

December 2013

# **BC63916 NPN Epitaxial Silicon Transistor**

#### **Features**

· Switching and Amplifier Applications



# **Ordering Information**

Part Number Top Mark		Package	Packing Method
BC63916_D74Z	BC639-16	TO-92 3L	Ammo
BC63916_D27Z	BC639-16	TO-92 3L	Tape and Reel

#### Absolute Maximum Ratings(1)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at  $T_A = 25^{\circ}\text{C}$  unless otherwise noted.

Symbol	Parameter	Value	Unit
$V_{CER}$	Collector-Emitter Voltage at $R_{BE}$ = 1 $k\Omega$	100	V
V <sub>CES</sub>	Collector-Emitter Voltage	100	V
V <sub>CEO</sub>	Collector-Emitter Voltage	80	V
$V_{EBO}$	Emitter-Base Voltage	5	V
I <sub>C</sub>	Collector Current	1	Α
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 to 150	°C

#### Note

1. Pulse test: pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2.0%.

# Thermal Characteristics(2)

Values are at T<sub>A</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Value	Unit
D	Power Dissipation	830	mW
$P_{D}$	Derate Above T <sub>A</sub> = 25°C	6.6	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	150	°C/W

#### Note:

2. PCB size: FR-4 76 x 114 x 0.6T mm<sup>3</sup> (3.0 inch x 4.5 inch x 0.062 inch) with minimum land pattern size.

#### **Electrical Characteristics**

Values are at  $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>CBO</sub>	Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_E = 0$	100			V
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = 10 mA, I <sub>B</sub> = 0	80			V
BV <sub>EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = 10 \mu A, I_C = 0$	5.0			V
I <sub>CBO</sub>	Collector Cut-Off Current	V <sub>CB</sub> = 30 V, I <sub>E</sub> = 0			100	nA
I <sub>EBO</sub>	Emitter Cut-Off Current	$V_{EB} = 5 \text{ V}, I_{C} = 0$		\	10	μΑ
h <sub>FE</sub> 1		$V_{CE} = 2 \text{ V}, I_{C} = 5 \text{ mA}$	25			
h <sub>FE</sub> 2	DC Current Gain	$V_{CE} = 2 \text{ V}, I_{C} = 150 \text{ mA}$	100		250	
h <sub>FE</sub> 3		$V_{CE} = 2 \text{ V}, I_{C} = 500 \text{ mA}$	25			
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 500 mA, I <sub>B</sub> = 50 mA			0.5	V
V <sub>BE</sub> (on)	Base-Emitter On Voltage	V <sub>CE</sub> = 2 V, I <sub>C</sub> = 500 mA			1	V
f <sub>T</sub>	Current Gain Bandwidth Product	V <sub>CE</sub> = 5 V, I <sub>C</sub> = 10 mA, f = 50 MHz		100		MHz

#### **Physical Dimension**

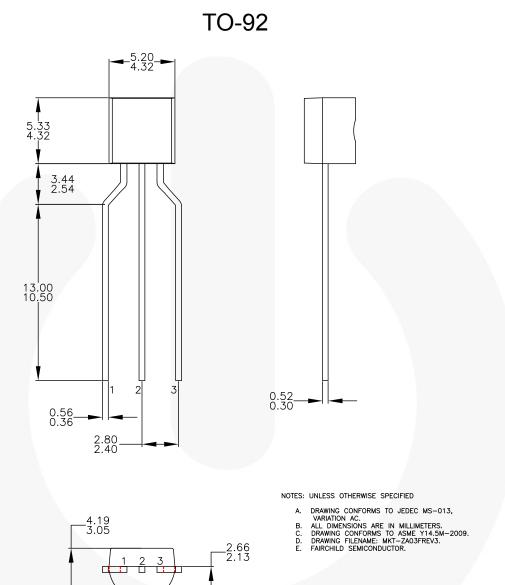


Figure 1. 3-LEAD, TO-92, MOLDED 0.200 IN-LINE SPACING LD FORM (J61Z OPTION) (ACTIVE)

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